

## APBD3224LSURKZGKC

3.2 x 2.4 mm SMD Chip LED Lamp

### DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

### FEATURES

- 3.2 x 2.4 mm SMD LED, 2.4 mm thickness
- Low power consumption
- Ideal for backlight and indicator
- Package: 1500 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

### APPLICATIONS

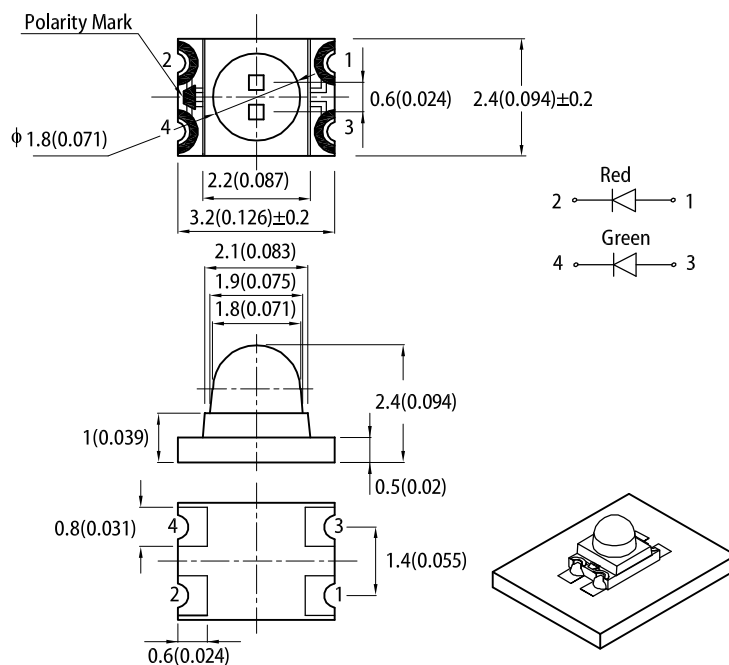
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

### ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

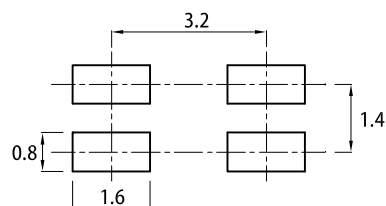


### PACKAGE DIMENSIONS



### RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



#### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.1(0.004") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

### SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 2mA <sup>[2]</sup>		Viewing Angle <sup>[1]</sup>
			Min.	Typ.	2θ1/2
APBD3224LSURKZGKC	■ Hyper Red (AlGaInP)	Water Clear	20	50	20°
	■ Green (InGaN)		*10	*30	
			120	250	
			*120	*250	

Notes:  
 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.  
 2. Luminous intensity / luminous flux: +/-15%.  
 \* Luminous intensity value is traceable to CIE127-2007 standards.

**ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C**

Parameter	Symbol	Emitting Color	Value			Unit
			Min.	Typ.	Max.	
Wavelength at Peak Emission I <sub>F</sub> = 2mA	λ <sub>peak</sub>	Hyper Red Green	-	645 515	-	nm
Dominant Wavelength I <sub>F</sub> = 2mA	λ <sub>dom</sub> <sup>[1]</sup>	Hyper Red Green	-	630 525	-	nm
Spectral Bandwidth at 50% Φ REL MAX I <sub>F</sub> = 2mA	Δλ	Hyper Red Green	-	28 45	-	nm
Capacitance	C	Hyper Red Green	-	35 45	-	pF
Forward Voltage I <sub>F</sub> = 2mA	V <sub>F</sub> <sup>[2]</sup>	Hyper Red Green	1.5 2.2	1.75 2.65	2.1 3.1	V
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	Hyper Red Green	-	-	10 50	μA
Temperature Coefficient of λ <sub>peak</sub> I <sub>F</sub> = 2mA, -10°C ≤ T ≤ 85°C	TC <sub>λpeak</sub>	Hyper Red Green	-	0.14 0.05	-	nm/°C
Temperature Coefficient of λ <sub>dom</sub> I <sub>F</sub> = 2mA, -10°C ≤ T ≤ 85°C	TC <sub>λdom</sub>	Hyper Red Green	-	0.05 0.03	-	nm/°C
Temperature Coefficient of V <sub>F</sub> I <sub>F</sub> = 2mA, -10°C ≤ T ≤ 85°C	TC <sub>V</sub>	Hyper Red Green	-	-1.9 -3	-	mV/°C

**Notes:**

1. The dominant wavelength (λ<sub>d</sub>) above is the setup value of the sorting machine. (Tolerance λ<sub>d</sub> : ±1nm. )
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

**ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C**

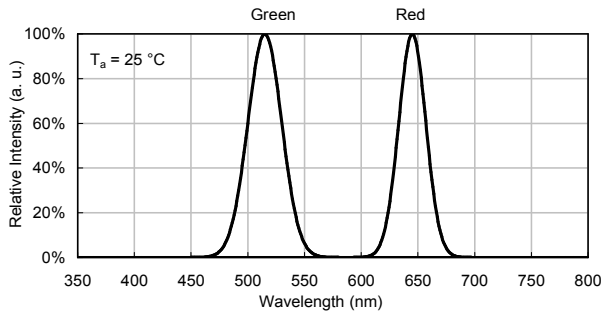
Parameter	Symbol	Value		Unit
		Hyper Red	Green	
Power Dissipation	P <sub>D</sub>	75	102.5	mW
Reverse Voltage	V <sub>R</sub>	5	5	V
Junction Temperature	T <sub>J</sub>	115	115	°C
Operating Temperature	T <sub>op</sub>	-40 To +85		°C
Storage Temperature	T <sub>stg</sub>	-40 To +85		°C
DC Forward Current	I <sub>F</sub>	30	25	mA
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	185	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	450	V
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> <sup>[2]</sup>	660	650	°C/W
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	560	550	°C/W

**Notes:**

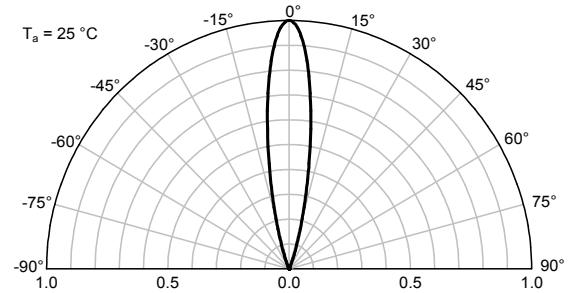
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. R<sub>th JA</sub>, R<sub>th JS</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm<sup>2</sup> per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

## TECHNICAL DATA

### RELATIVE INTENSITY vs. WAVELENGTH

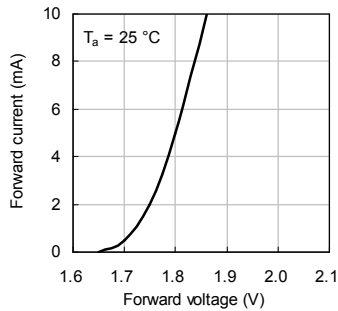


### SPATIAL DISTRIBUTION

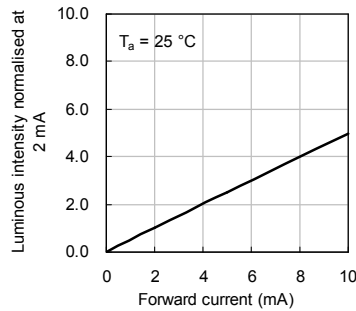


## HYPER RED

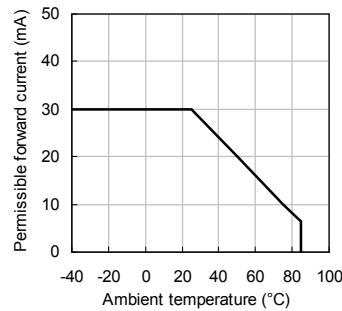
Forward Current vs. Forward Voltage



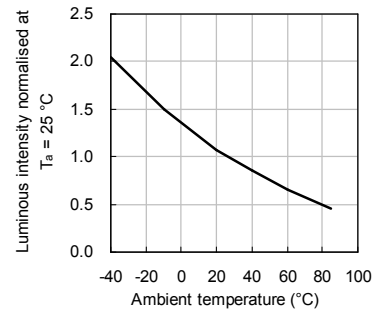
Luminous Intensity vs. Forward Current



Forward Current Derating Curve

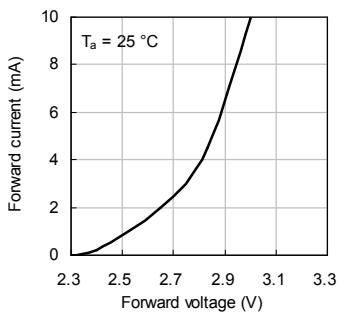


Luminous Intensity vs. Ambient Temperature

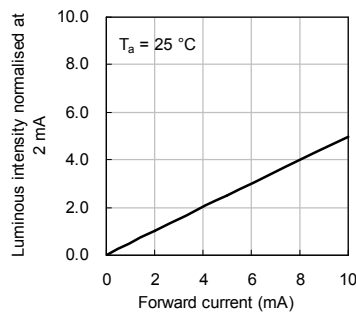


## GREEN

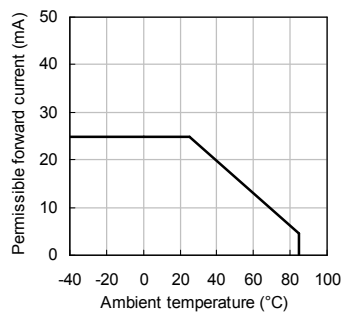
Forward Current vs. Forward Voltage



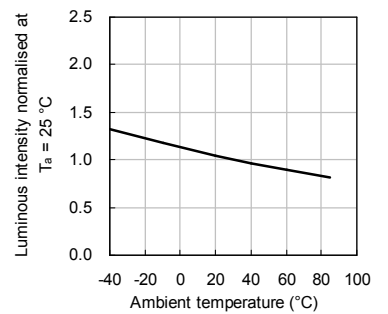
Luminous Intensity vs. Forward Current



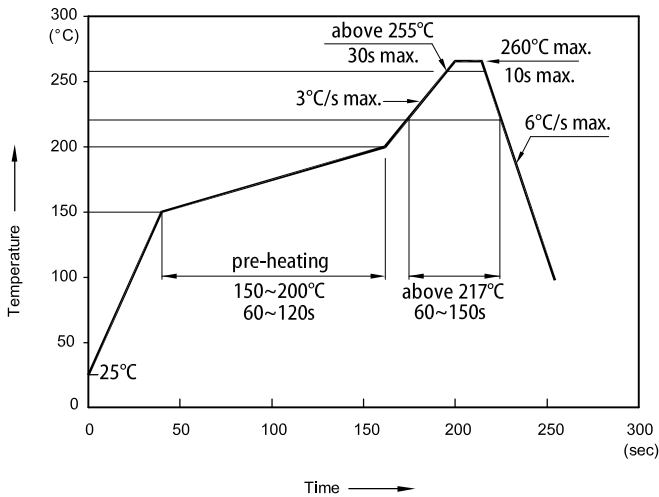
Forward Current Derating Curve



Luminous Intensity vs. Ambient Temperature

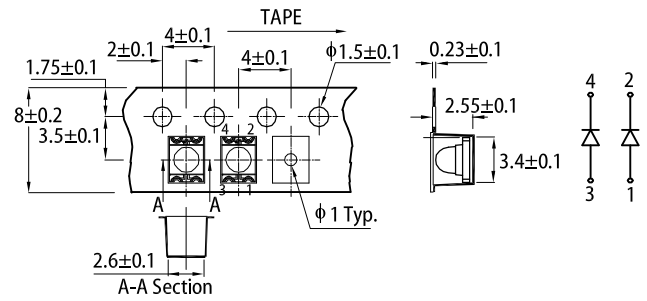


## REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

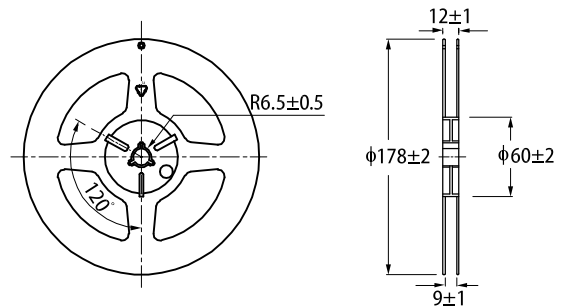


- Notes:
1. Don't cause stress to the LEDs while it is exposed to high temperature.
  2. The maximum number of reflow soldering passes is 2 times.
  3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

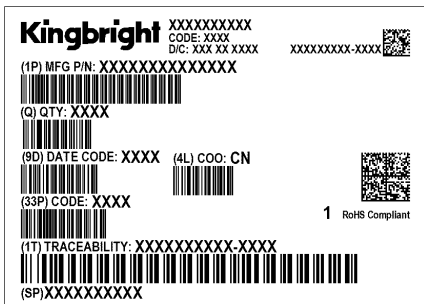
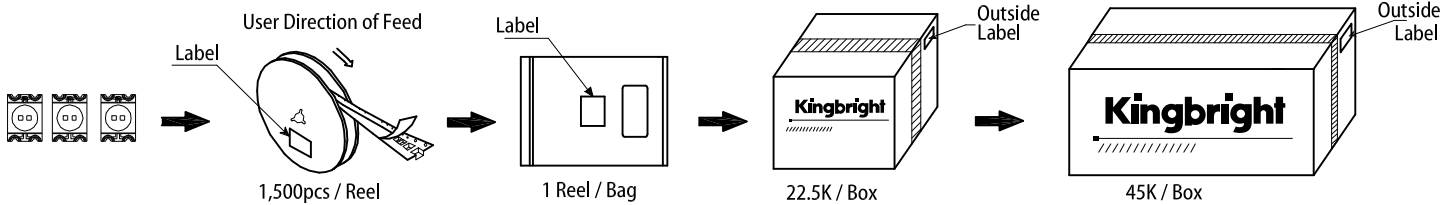
## TAPE SPECIFICATIONS (units : mm)



## REEL DIMENSION (units : mm)



## PACKING & LABEL SPECIFICATIONS



## PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
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